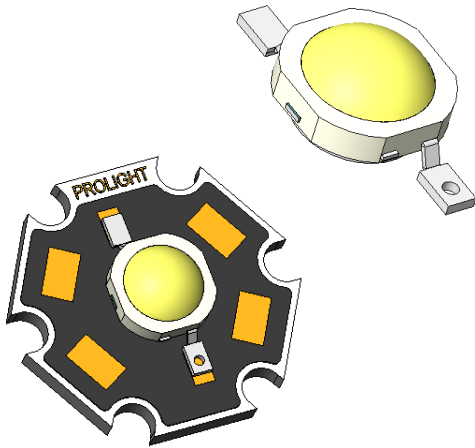




ProLight Opto
Technology Corporation



**ProLight PG1C-1Lxx
1W Power LED
Technical Datasheet
Version: 3.4**

Features

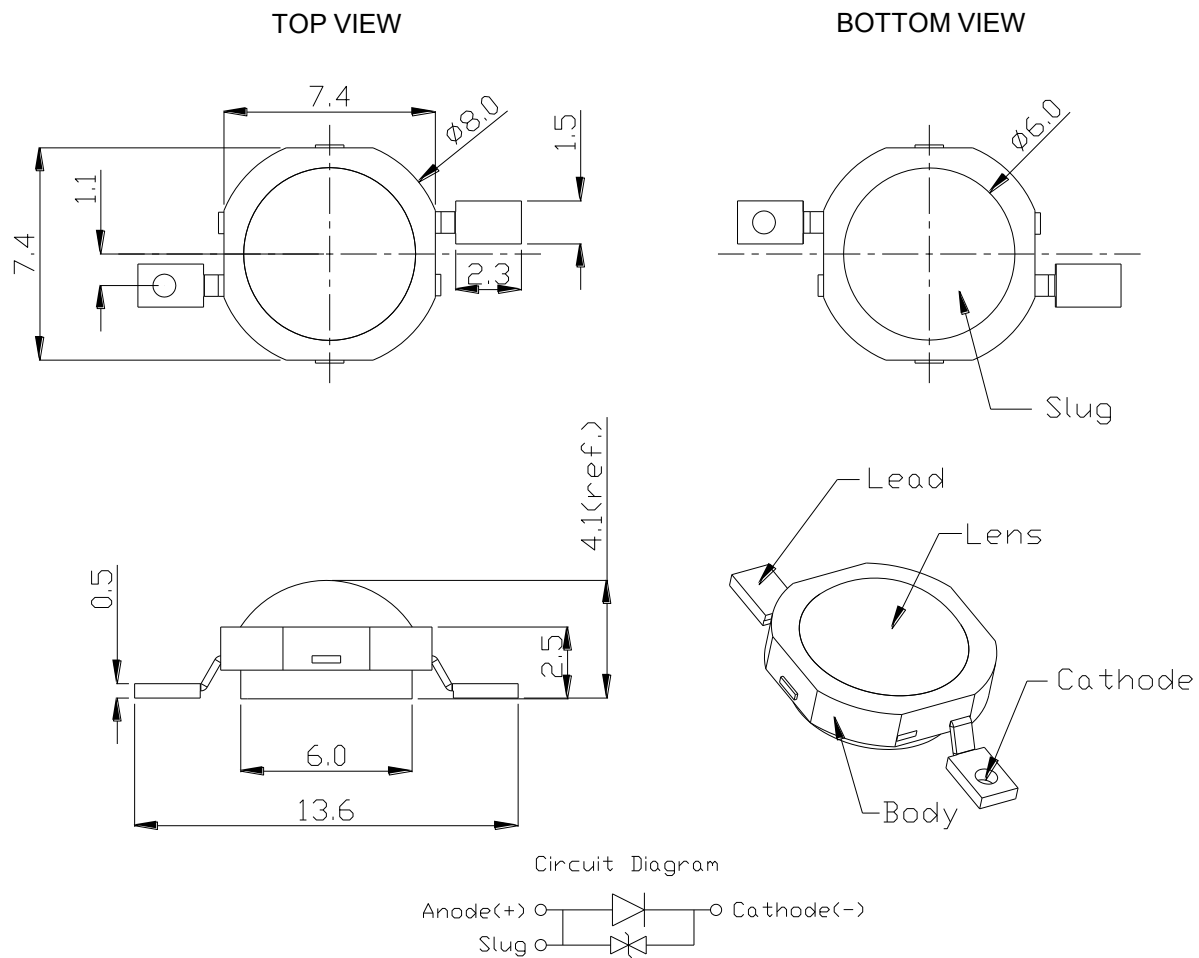
- High flux per LED
- Various colors
- Good color uniformity
- Industry best moisture sensitivity level - JEDEC 2a
4 week floor life without reconditioning
- Low-temp. & lead free reflow soldering
- RoHS compliant
- More energy efficient than incandescent and most halogen lamps
- Low Voltage DC operated
- Instant light (less than 100ns)
- No UV
- Superior ESD protection

Typical Applications

- Reading lights (car, bus, aircraft)
- Portable (flashlight, bicycle)
- Uplighters/Downlighters
- Decorative/Entertainment
- Bollards/Security/Garden
- Cove/Undershelf/Task
- Indoor/Outdoor Commercial and Residential Architectural
- Automotive Ext (Stop-Tail-Turn, CHMSL, Mirror Side Repeat)
- LCD backlights

ProLight

Emitter Mechanical Dimensions

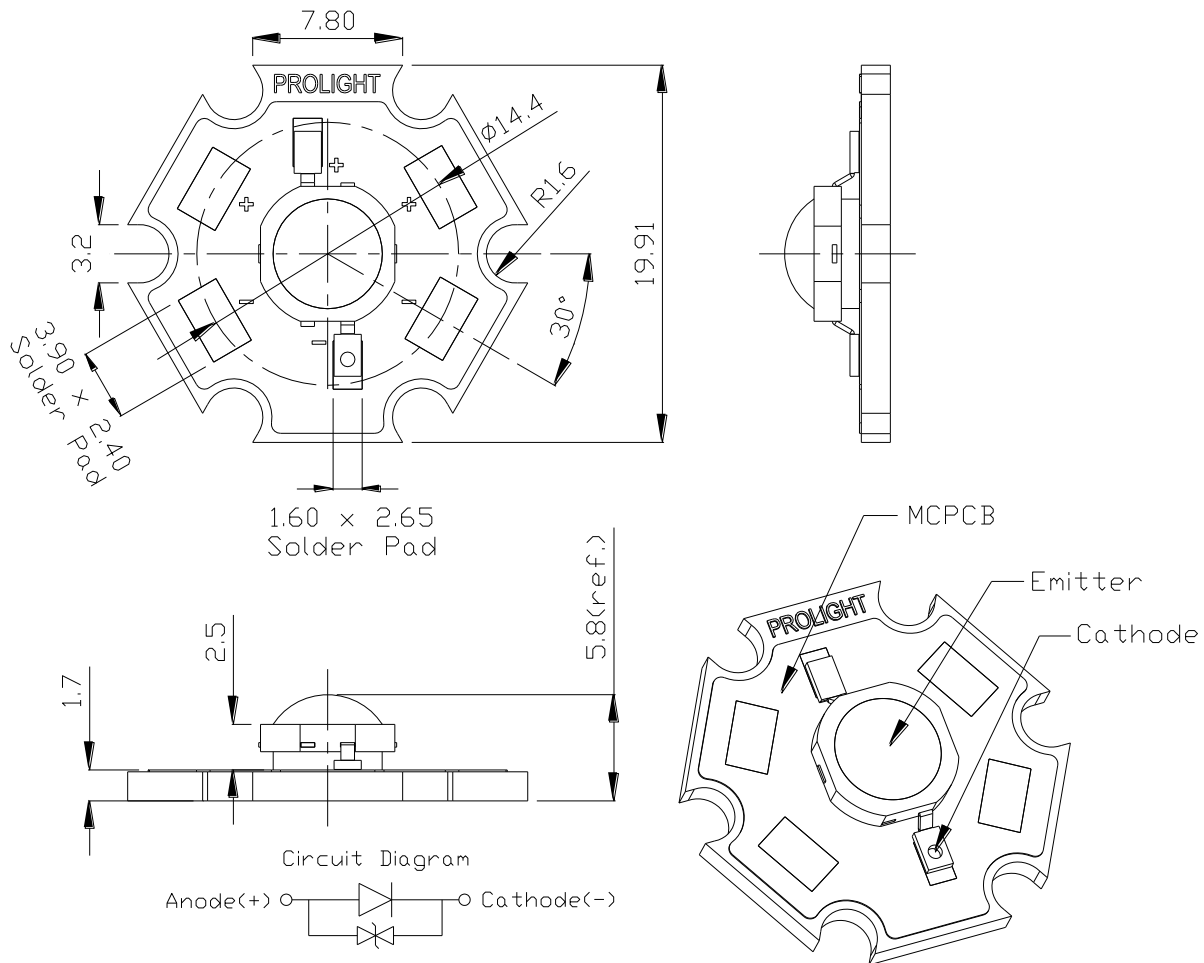


Notes:

1. The Anode side of the device is denoted by a hole in the lead frame.
2. Electrical insulation between the case and the board is required --- slug of device is not electrically neutral. Do not electrically connect either the anode or cathode to the slug.
3. Drawing not to scale.
4. All dimensions are in millimeters.
5. All dimensions without tolerances are for reference only.
6. Please do not bend the leads of the LED, otherwise it will damage the LED.
7. **Please do not use a force of over 3kgf impact or pressure on the lens of the LED, otherwise it will cause a catastrophic failure.**

*The appearance and specifications of the product may be modified for improvement without notice.

Star Mechanical Dimensions



Notes:

1. Slots in aluminum-core PCB for M3 or #4 mounting screw.
2. Electrical interconnection pads labeled on the aluminum-core PCB with "+" and "-" to denote positive and negative, respectively. All positive pads are interconnected, as are all negative pads, allowing for flexibility in array interconnection.
3. Drawing not to scale.
4. All dimensions are in millimeters.
5. All dimensions without tolerances are for reference only.
6. **Please do not use a force of over 3kgf impact or pressure on the lens of the LED, otherwise it will cause a catastrophic failure.**

*The appearance and specifications of the product may be modified for improvement without notice.

ProLight

Flux Characteristics at 350mA, T_J = 25°C

Radiation Pattern	Color	Part Number		Lumious Flux or Power	
		Emitter	Star	Minimum	Typical
Lambertian	White	PG1C-1LWE	PG1C-1LWS	76.6 lm	87 lm
	Warm White	PG1C-1LVE	PG1C-1LVS	67.2 lm	81 lm
	Crimson	PG1C-1LME	PG1C-1LMS	10.7 lm	16 lm
	Red	PG1C-1LRE	PG1C-1LRS	30.6 lm	45 lm
	Amber	PG1C-1LAE	PG1C-1LAS	30.6 lm	47 lm
	Green	PG1C-1LGE	PG1C-1LGS	58.9 lm	66 lm
	Cyan	PG1C-1LCE	PG1C-1LCS	39.8 lm	53 lm
	Blue	PG1C-1LBE	PG1C-1LBS	10.7 lm	18 lm
	Royal Blue	PG1C-1LDE	PG1C-1LDS	225 mW	300 mW
	UV	PG1C-1LLE	PG1C-1LLS	225 mW	270 mW
	Cherry Red	PG1C-1LEE	PG1C-1LES	115 mW	150 mW

- ProLight maintains a tolerance of $\pm 10\%$ on flux and power measurements.
- Please do not drive at rated current more than 1 second without proper heat sink.

Electrical Characteristics at 350mA, T_J = 25°C

Color	Forward Voltage V _F (V)			Thermal Resistance Junction to Slug (°C/ W)
	Min.	Typ.	Max.	
White	2.85	3.5	4.1	10
Warm White	2.85	3.5	4.1	10
Crimson	1.75	2.2	3.0	10
Red	1.75	2.2	3.0	10
Amber	1.75	2.2	3.0	10
Green	2.85	3.5	4.1	10
Cyan	2.85	3.5	4.1	10
Blue	2.85	3.5	4.1	10
Royal Blue	2.85	3.5	4.1	10
UV	2.85	3.5	4.1	10
Cherry Red	1.75	2.2	3.0	10

Optical Characteristics at 350mA, T_J = 25°C

Color	Dominant Wavelength λ_D , Peak Wavelength ^[1] λ_P , or Color Temperature CCT			Total included Angle (degrees)	Viewing Angle (degrees)
	Min.	Typ.	Max.	$\theta_{0.90V}$	2 $\theta_{1/2}$
White	4100 K	5500 K	10000 K	160	140
Warm White	2700 K	3300 K	4100 K	160	140
Crimson	635 nm	640 nm	645 nm	160	140
Red	613.5 nm	623 nm	631 nm	160	140
Amber	587 nm	592 nm	597 nm	160	140
Green	515 nm	525 nm	535 nm	160	140
Cyan	495 nm	505 nm	515 nm	160	140
Blue	455 nm	465 nm	475 nm	160	140
Royal Blue	450 nm	455 nm	460nm	160	140
UV ^[1]	390 nm	400 nm	410 nm	160	140
Cherry Red ^[1]	720 nm	730 nm	740 nm	160	140

- ProLight maintains a tolerance of ± 1 nm for dominant wavelength measurements.
- ProLight maintains a tolerance of $\pm 5\%$ for CCT measurements.
- ^[1] UV, Cherry Red, product is binned by radiometric power and peak wavelength rather than photometric lumens and dominant wavelength. ProLight Lumileds maintains a tolerance of ± 2 nm for peak wavelength measurements.

Absolute Maximum Ratings

Parameter	White/Warm White/Crimson/Red/Amber/ Green/Cya/Blue/Royal Blue/UV/Cherry Red
DC Forward Current (mA)	350
Peak Pulsed Forward Current (mA)	500
Average Forward Current (mA)	350
ESD Sensitivity (HBM per MIL-STD-883E Method 3015.7)	$\pm 4000V$ (Class III)
LED Junction Temperature (°C)	120
Aluminum-core PCB Temperature (°C)	105
Storage & Operating Temperature (°C)	-40 to +105
Soldering Temperature(°C)	235°C

ProLight

Radiometric Power Bin Structure

Color	Bin Code	Minimum Radiometric Power (mW)	Maximum Radiometric Power (mW)	Available Color Bins
Royal Blue	M	225	275	All
	N	275	355	All
	P	355	435	All
UV	M	225	275	1, 2 ^[1]
	N	275	355	All
	P	355	435	^[1]
Cherry Red	J	6.3	8.2	All
	K	8.2	10.7	^[1]

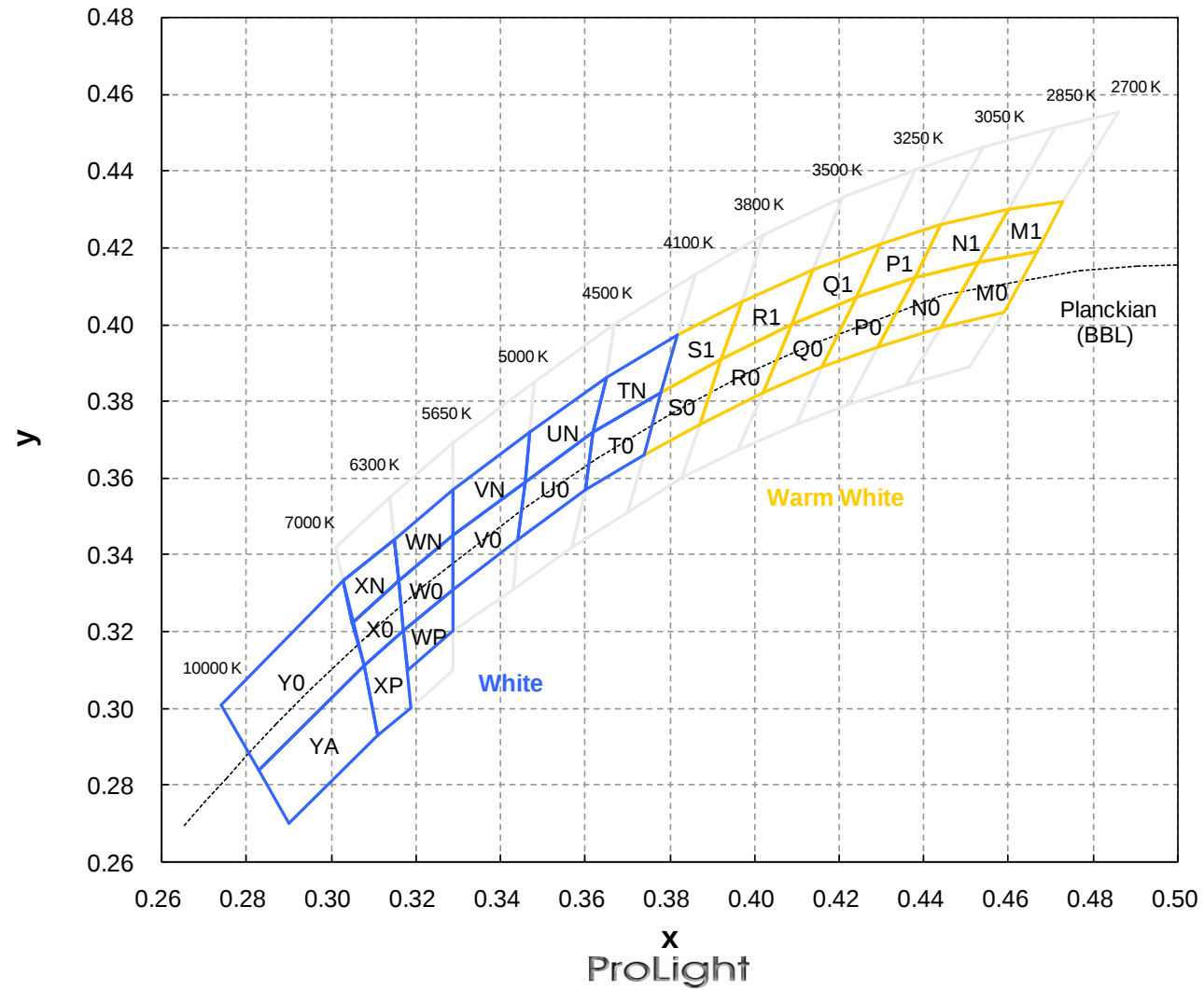
- ProLight maintains a tolerance of $\pm 10\%$ on flux and power measurements.
- The flux bin of the product may be modified for improvement without notice.
- ^[1] The rest of color bins are not 100% ready for order currently. Please ask for quote and order possibility.

Photometric Luminous Flux Bin Structure

Color	Bin Code	Minimum Photometric Flux (lm)	Maximum Photometric Flux (lm)	Available Color Bins
White	T2	76.6	87.4	All
	U1	87.4	99.6	Yx, Xx, Wx, Vx, Ux ^[1]
Warm White	T1	67.2	76.6	All
	T2	76.6	87.4	All
	U1	87.4	99.6	Sx, Rx ^[1]
Crimson	L	10.7	13.9	All
	M	13.9	18.1	All
	N	18.1	23.5	^[1]
Red	Q	30.6	39.8	All
	R	39.8	51.7	All
	S1	51.7	58.9	^[1]
Amber	Q	30.6	39.8	All
	R	39.8	51.7	All
	S1	51.7	58.9	^[1]
Green	S2	58.9	67.2	All
	T1	67.2	76.6	All
	T2	76.6	87.4	^[1]
Cyan	R	39.8	51.7	All
	S1	51.7	58.9	^[1]
Blue	L	10.7	13.9	A, 1 ^[1]
	M	13.9	18.1	A, 1, 2 ^[1]
	N	18.1	23.5	2 ^[1]

- ProLight maintains a tolerance of $\pm 10\%$ on flux and power measurements.
- The flux bin of the product may be modified for improvement without notice.
- ^[1] The rest of color bins are not 100% ready for order currently. Please ask for quote and order possibility.

White and Warm White Binning Structure Graphical Representation



Color Bins

White Bin Structure

Bin Code	x	y	Typ. CCT (K)	Bin Code	x	y	Typ. CCT (K)
T0	0.378	0.382	4300	WN	0.329	0.345	5970
	0.374	0.366			0.316	0.333	
	0.360	0.357			0.315	0.344	
	0.362	0.372			0.329	0.357	
TN	0.382	0.397	4300	WP	0.329	0.331	5970
	0.378	0.382			0.329	0.320	
	0.362	0.372			0.318	0.310	
	0.365	0.386			0.317	0.320	
U0	0.362	0.372	4750	X0	0.308	0.311	6650
	0.360	0.357			0.305	0.322	
	0.344	0.344			0.316	0.333	
	0.346	0.359			0.317	0.320	
UN	0.365	0.386	4750	XN	0.305	0.322	6650
	0.362	0.372			0.303	0.333	
	0.346	0.359			0.315	0.344	
	0.347	0.372			0.316	0.333	
V0	0.329	0.331	5320	XP	0.308	0.311	6650
	0.329	0.345			0.317	0.320	
	0.346	0.359			0.319	0.300	
	0.344	0.344			0.311	0.293	
VN	0.329	0.345	5320	Y0	0.308	0.311	8000
	0.329	0.357			0.283	0.284	
	0.347	0.372			0.274	0.301	
	0.346	0.359			0.303	0.333	
W0	0.329	0.345	5970	YA	0.308	0.311	8000
	0.329	0.331			0.311	0.293	
	0.317	0.320			0.290	0.270	
	0.316	0.333			0.283	0.284	

- Tolerance on each color bin (x , y) is ± 0.01

Note: Although several bins are outlined, product availability in a particular bin varies by production run and by product performance. Not all bins are available in all colors.

Color Bins

Warm White Bin Structure

Bin Code	x	y	Typ. CCT (K)	Bin Code	x	y	Typ. CCT (K)
M0	0.453	0.416	2770	Q0	0.409	0.400	3370
	0.444	0.399			0.402	0.382	
	0.459	0.403			0.416	0.389	
	0.467	0.419			0.424	0.407	
M1	0.460	0.430	2770	Q1	0.414	0.414	3370
	0.453	0.416			0.409	0.400	
	0.467	0.419			0.424	0.407	
	0.473	0.432			0.430	0.421	
N0	0.438	0.412	2950	R0	0.392	0.391	3650
	0.429	0.394			0.387	0.374	
	0.444	0.399			0.402	0.382	
	0.453	0.416			0.409	0.400	
N1	0.444	0.426	2950	R1	0.414	0.414	3650
	0.438	0.412			0.409	0.400	
	0.453	0.416			0.392	0.391	
	0.460	0.430			0.397	0.406	
P0	0.424	0.407	3150	S0	0.392	0.391	3950
	0.416	0.389			0.387	0.374	
	0.429	0.394			0.374	0.366	
	0.438	0.412			0.378	0.382	
P1	0.430	0.421	3150	S1	0.397	0.406	3950
	0.424	0.407			0.392	0.391	
	0.438	0.412			0.378	0.382	
	0.444	0.426			0.382	0.397	

- Tolerance on each color bin (x , y) is ± 0.01

Note: Although several bins are outlined, product availability in a particular bin varies by production run and by product performance. Not all bins are available in all colors.

Peak Wavelength Bin Structure

Color	Bin Code	Minimum Peak Wavelength (nm)	Maximum Peak Wavelength (nm)
UV	1	390	395
	2	395	400
	3	400	405
	4	405	410
Cherry Red	1	720	740

- ProLight maintains a tolerance of $\pm 1\text{nm}$ for peak wavelength measurements.

Dominant Wavelength Bin Structure

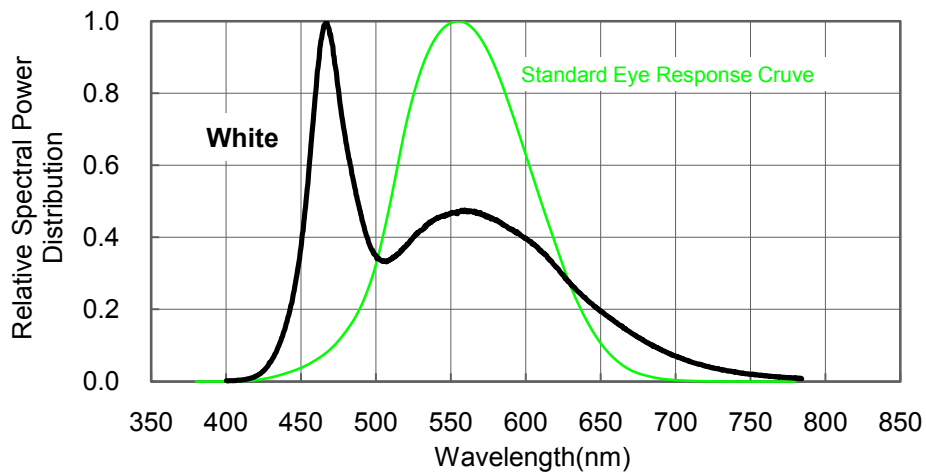
Color	Bin Code	Minimum Dominant Wavelength (nm)	Maximum Dominant Wavelength (nm)
Crimson	1	635	645
Red	2	613.5	620.5
	4	620.5	631.0
Amber	2	587.0	589.5
	4	589.5	592.0
	6	592.0	594.5
	7	594.5	597.0
Green	A	515	520
	1	520	525
	2	525	530
	3	530	535
Cyan	A	495	500
	1	500	505
	2	505	510
	3	510	515
Blue	A	455	460
	1	460	465
	2	465	470
	3	470	475
Royal Blue	5	450	455
	6	455	460

- ProLight maintains a tolerance of $\pm 1\text{nm}$ for dominant wavelength measurements.

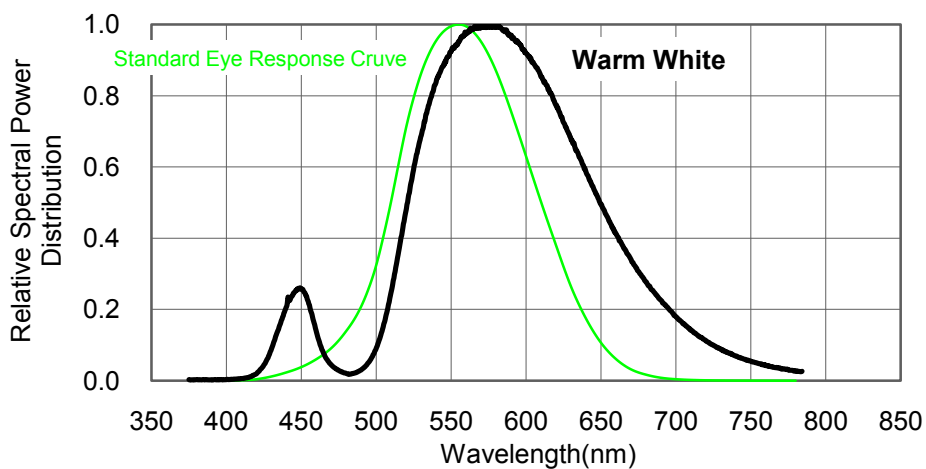
Note: Although several bins are outlined, product availability in a particular bin varies by production run and by product performance. Not all bins are available in all colors.

Color Spectrum, $T_J = 25^{\circ}\text{C}$

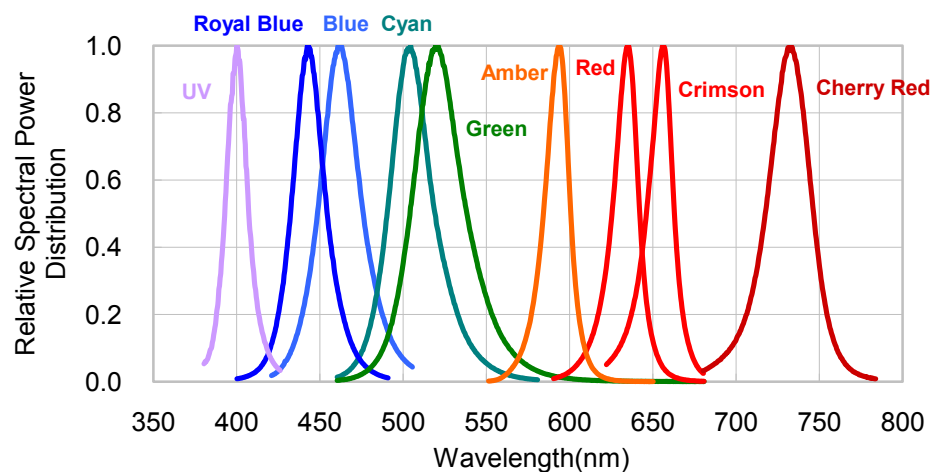
1. White



2. Warm White



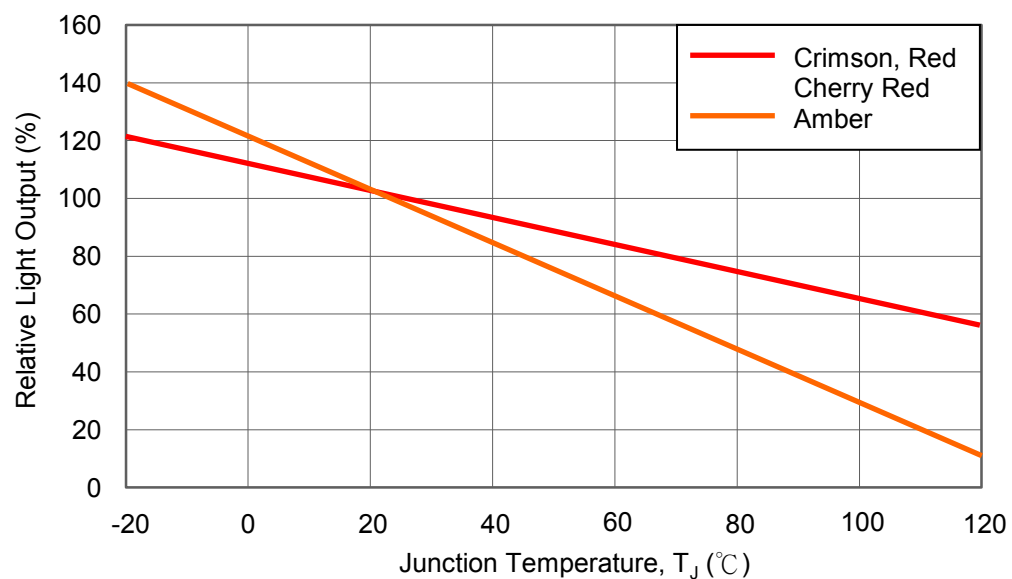
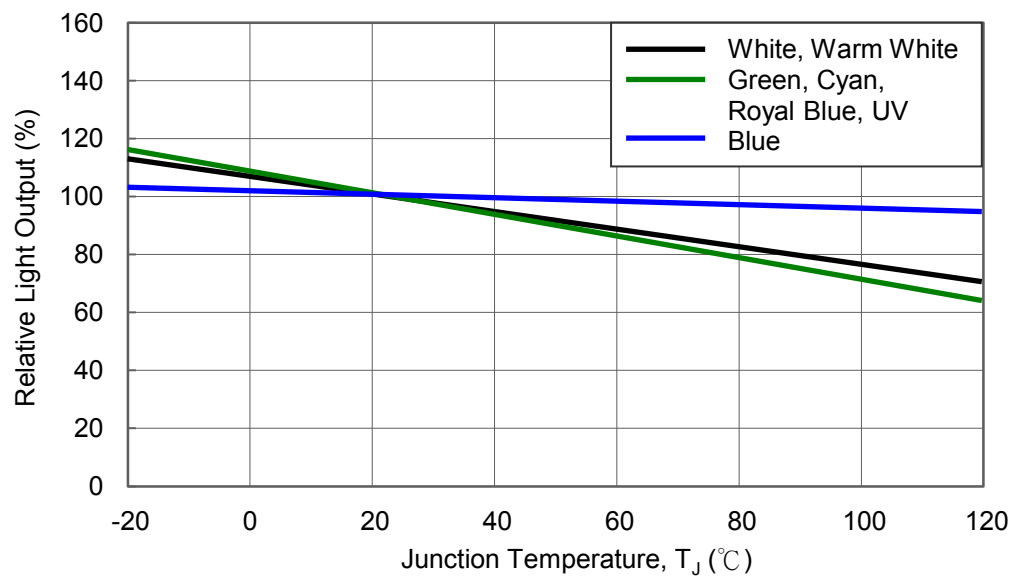
3. UV 、 Royal Blue 、 Blue 、 Cyan 、 Green 、 Amber 、 Red 、 Crimson 、 Cherry Red



ProLight

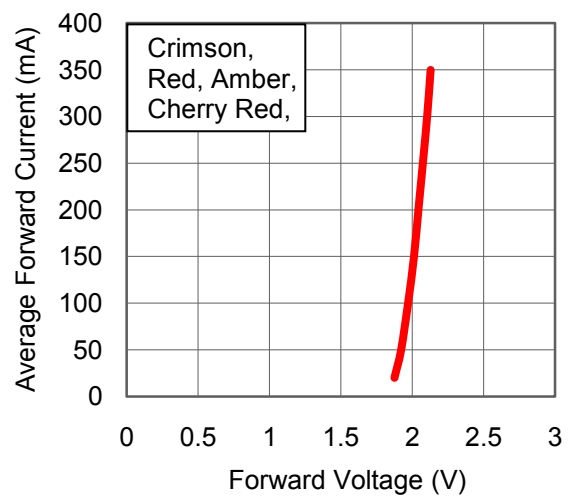
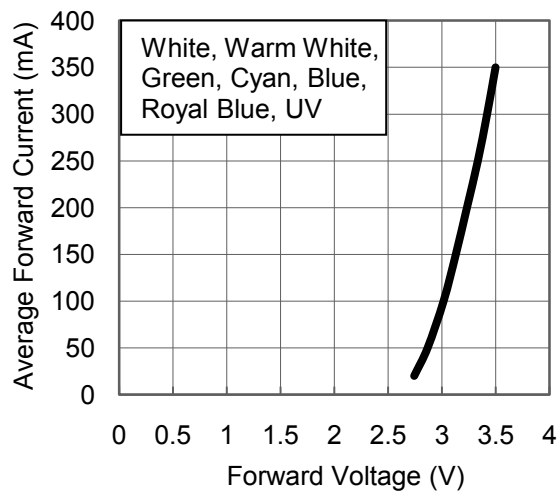
Light Output Characteristics

Relative Light Output vs. Junction Temperature at 350mA

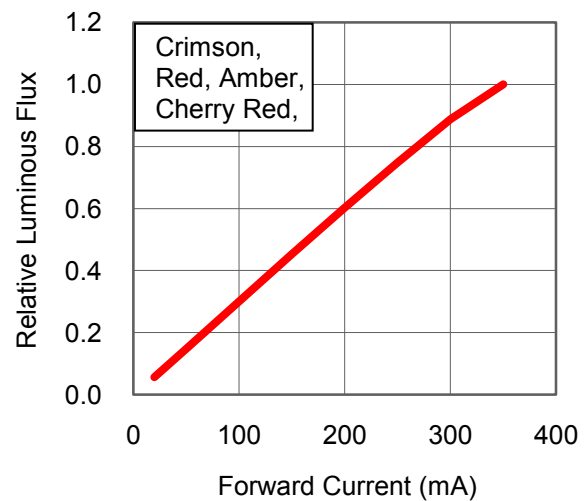
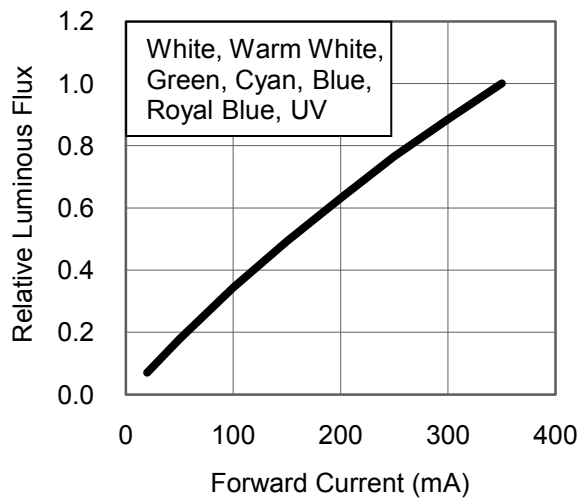


Forward Current Characteristics, $T_J = 25^\circ\text{C}$

1. Forward Voltage vs. Forward Current

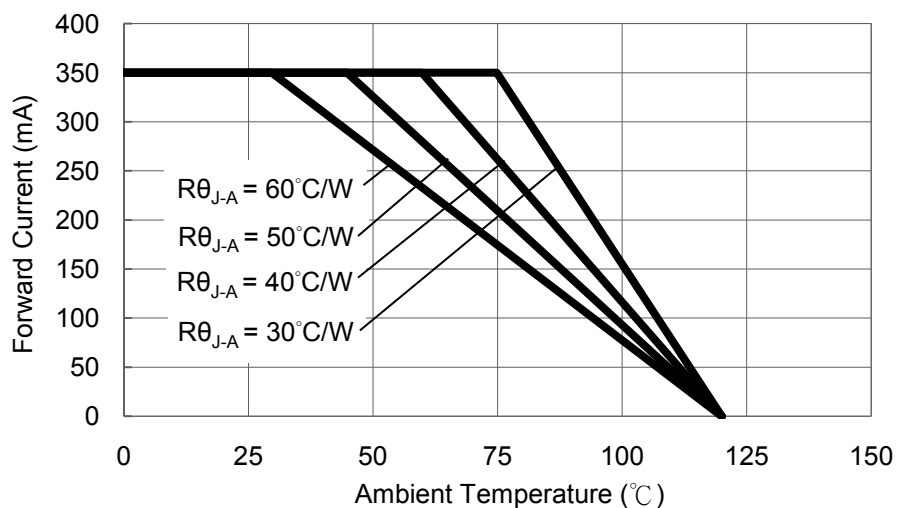


2. Forward Current vs. Normalized Relative Luminous Flux

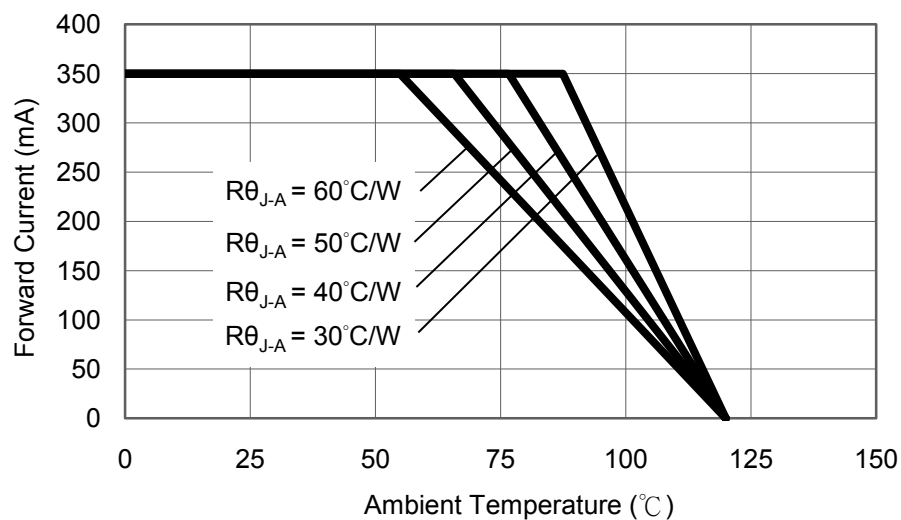


Ambient Temperature vs. Maximum Forward Current

1. White, Warm White, Green, Cyan, Blue, Royal Blue, UV ($T_{JMAX} = 120^{\circ}\text{C}$)

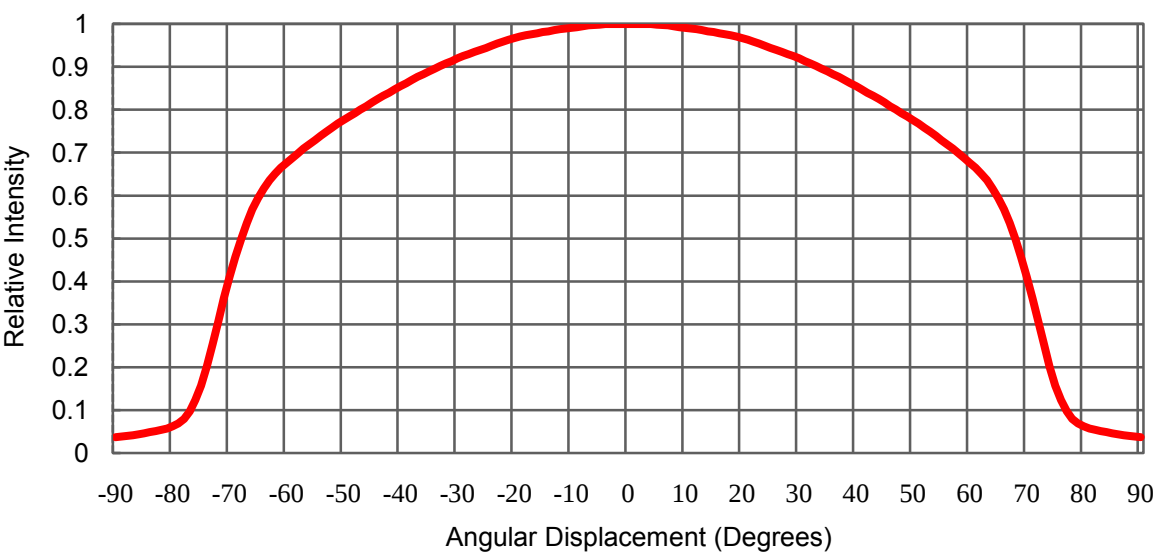


2. Crimson, Red, Amber, Cherry Red ($T_{JMAX} = 120^{\circ}\text{C}$)



Typical Representative Spatial Radiation Pattern

Lambertian Radiation Pattern



Moisture Sensitivity Level - JEDEC 2a

Level	Floor Life		Soak Requirements			
			Standard		Accelerated Environment	
	Time	Conditions	Time (hours)	Conditions	Time (hours)	Conditions
2a	4 weeks	$\leq 30^{\circ}\text{C}$ / 60% RH	696 +5/-0	30°C / 60% RH	120 +1/-0	60°C / 60% RH

- The standard soak time includes a default value of 24 hours for semiconductor manufacture's exposure time (MET) between bake and bag and includes the maximum time allowed out of the bag at the distributor's facility.
- Table below presents the moisture sensitivity level definitions per IPC/JEDEC's J-STD-020C.

Level	Floor Life		Soak Requirements			
			Standard		Accelerated Environment	
	Time	Conditions	Time (hours)	Conditions	Time (hours)	Conditions
1	Unlimited	$\leq 30^{\circ}\text{C}$ / 85% RH	168 +5/-0	85°C / 85% RH	NA	NA
2	1 year	$\leq 30^{\circ}\text{C}$ / 60% RH	168 +5/-0	85°C / 60% RH	NA	NA
2a	4 weeks	$\leq 30^{\circ}\text{C}$ / 60% RH	696 +5/-0	30°C / 60% RH	120 +1/-0	60°C / 60% RH
3	168 hours	$\leq 30^{\circ}\text{C}$ / 60% RH	192 +5/-0	30°C / 60% RH	40 +1/-0	60°C / 60% RH
4	72 hours	$\leq 30^{\circ}\text{C}$ / 60% RH	96 +2/-0	30°C / 60% RH	20 +0.5/-0	60°C / 60% RH
5	48 hours	$\leq 30^{\circ}\text{C}$ / 60% RH	72 +2/-0	30°C / 60% RH	15 +0.5/-0	60°C / 60% RH
5a	24 hours	$\leq 30^{\circ}\text{C}$ / 60% RH	48 +2/-0	30°C / 60% RH	10 +0.5/-0	60°C / 60% RH
6	Time on Label (TOL)	$\leq 30^{\circ}\text{C}$ / 60% RH	Time on Label (TOL)	30°C / 60% RH	NA	NA

Qualification Reliability Testing

Stress Test	Stress Conditions	Stress Duration	Failure Criteria
Room Temperature Operating Life (RTOL)	25°C, $I_F = \text{max DC}$ (Note 1)	1000 hours	Note 2
Wet High Temperature Operating Life (WHTOL)	85°C/60%RH, $I_F = \text{max DC}$ (Note 1)	1000 hours	Note 2
Wet High Temperature Storage Life (WHTSL)	85°C/85%RH, non-operating	1000 hours	Note 2
High Temperature Storage Life (HTSL)	110°C, non-operating	1000 hours	Note 2
Low Temperature Storage Life (LTSL)	-40°C, non-operating	1000 hours	Note 2
Non-operating Temperature Cycle (TMCL)	-40°C to 120°C, 30 min. dwell, <5 min. transfer	200 cycles	Note 2
Non-operating Thermal Shock (TMSK)	-40°C to 120°C, 20 min. dwell, <20 sec. transfer	200 cycles	Note 2
Mechanical Shock	1500 G, 0.5 msec. pulse, 5 shocks each 6 axis		Note 3
Natural Drop	On concrete from 1.2 m, 3X		Note 3
Variable Vibration Frequency	10-2000-10 Hz, log or linear sweep rate, 20 G about 1 min., 1.5 mm, 3X/axis		Note 3
Solder Heat Resistance (SHR)	260°C $\pm$ 5°C, 10 sec.		Note 3
Solderability	Steam age for 16 hrs., then solder dip at 260°C for 5 sec.		Solder coverage on lead

Notes:

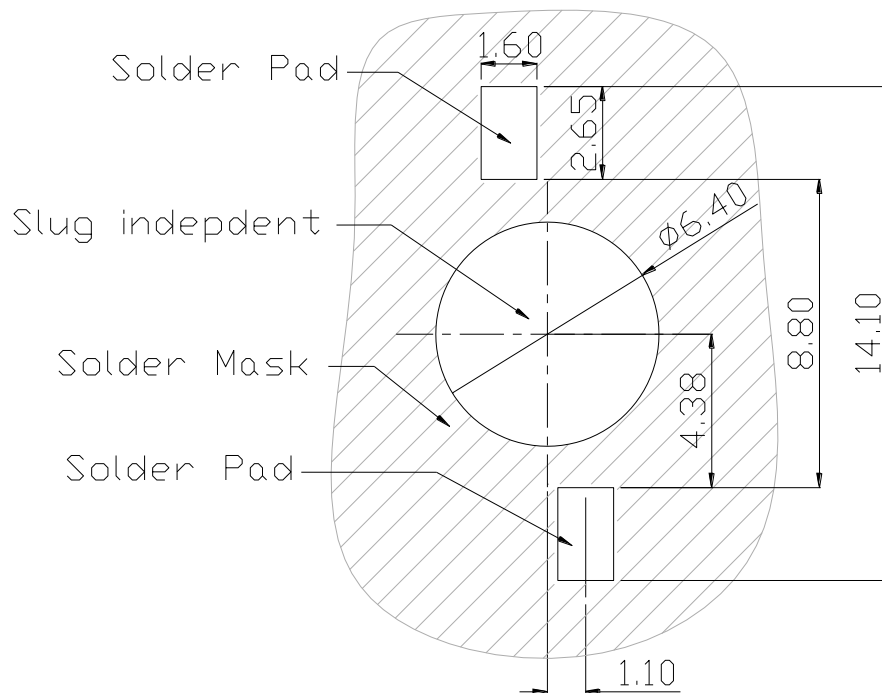
1. Depending on the maximum derating curve.
2. Criteria for judging failure

Item	Test Condition	Criteria for Judgement	
		Min.	Max.
Forward Voltage (V_F)	$I_F = \text{max DC}$	--	Initial Level x 1.1
Luminous Flux or Radiometric Power (Φ_V)	$I_F = \text{max DC}$	Initial Level x 0.7	--
Reverse Current (I_R)	$V_R = 5V$	--	50 μA

* The test is performed after the LED is cooled down to the room temperature.

3. A failure is an LED that is open or shorted.

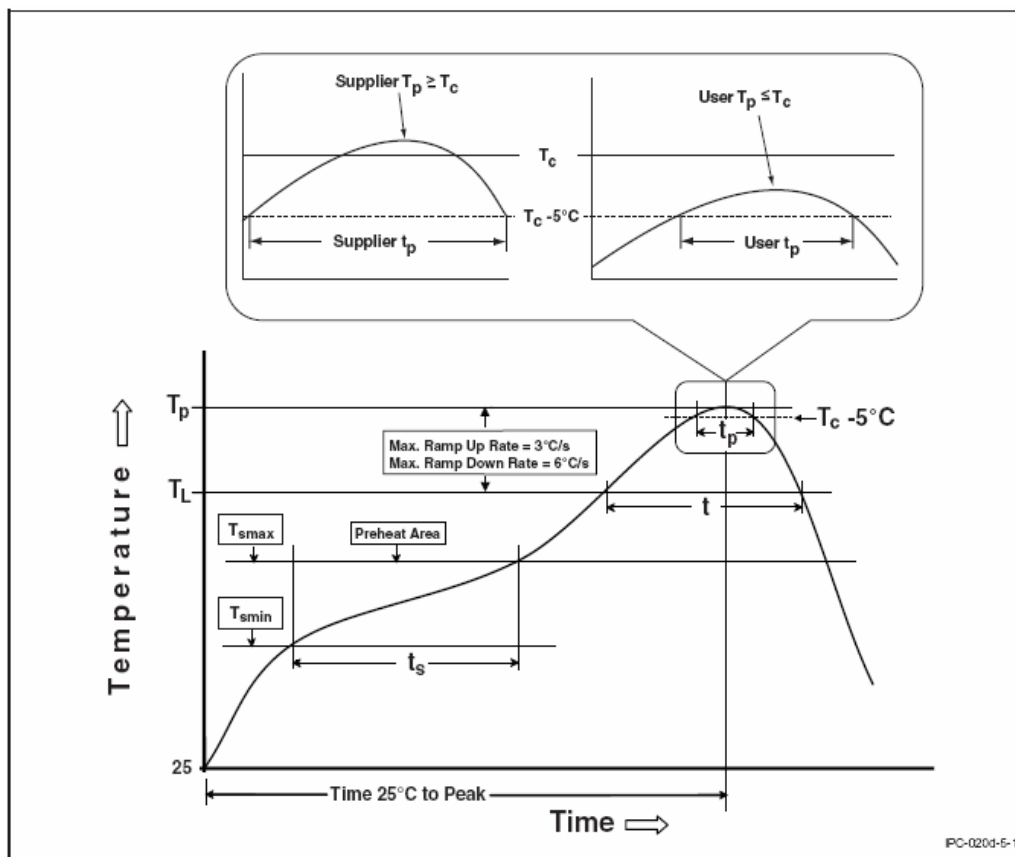
Recommended Solder Pad Design



- All dimensions are in millimeters.
- Electrical isolation is required between Slug and Solder Pad.

Reflow Soldering Condition

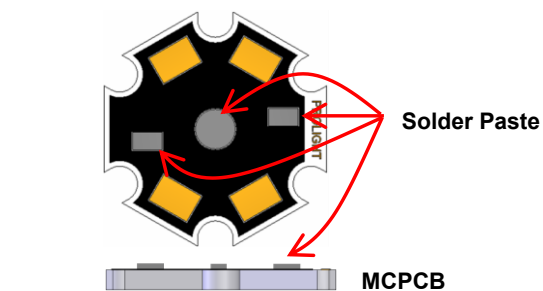
Profile Feature	Sn-Pb Eutectic Assembly	Low-Temp. & Pb-Free Assembly (58Bi-42Sn Eutectic Alloy)
Preheat & Soak		
Temperature min (T_{smin})	100 °C	90 °C
Temperature max (T_{smax})	150 °C	120 °C
Time (T_{smin} to T_{smax})	60-120 seconds	60-120 seconds
Average Ramp-Up Rate (T_{smax} to T_P)	3 °C / second max.	2 °C / second max.
Liquidous temperature (T_L)	183°C	138°C
Time at liquidous (t_L)	60-150 seconds	20-50 seconds
Peak package body temperature (T_P)	235°C	185°C
Time (t_P) within 5°C of the specified classification temperature (T_C)	20 seconds	20 seconds
Average ramp-down rate (T_P to T_{smax})	6 °C/second max.	3 °C/second max.
Time 25°C to Peak Temperature	6 minutes max.	4 minutes max.



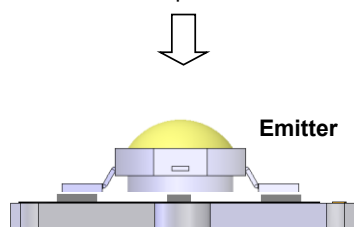
- All temperatures refer to topside of the package, measured on the package body surface.
- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, a heat plate should be used. It should be confirmed beforehand whether the characteristics of LEDs will or will not be damaged by repairing.
- Reflow soldering should not be done more than two times.
- When soldering, do not put stress on the LEDs during heating.
- After soldering, do not warp the circuit board.

Heat Plate Soldering Condition

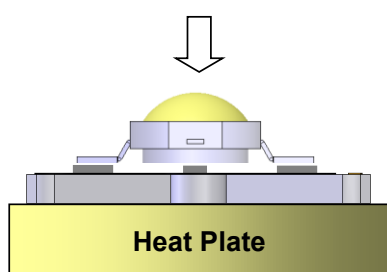
(1) Soldering Process for Solder Paste



Use Solder Mask to print Solder Paste on MCPCB.

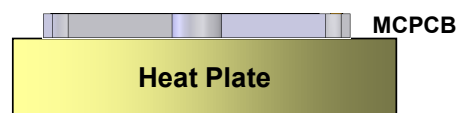


Place Emitter on MCPCB.

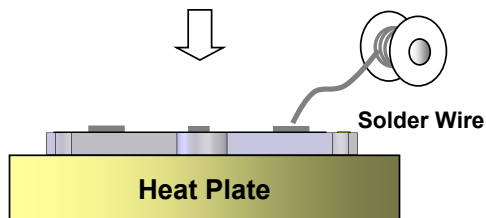


Put MCPCB on Heat Plate until Solder Paste melt.
The Solder Paste could be melted within 10 seconds.
Take out MCPCB out from Heat Plate within 15 seconds.

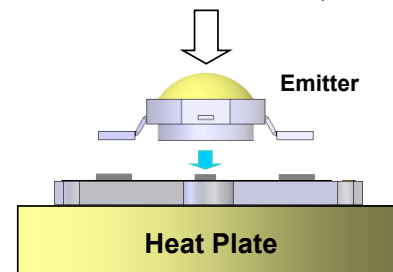
(2) Soldering Process for Solder Wire



Put MCPCB on Heat Plate.



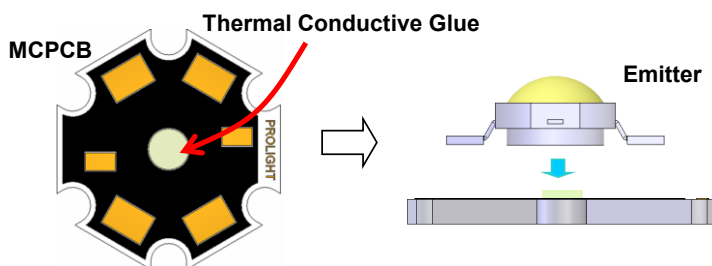
Place Solder Wire to the solder pad of MCPCB.



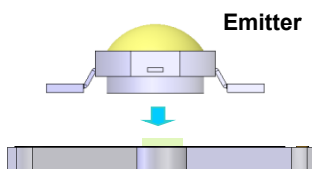
Put Emitter on MCPCB. Take the MCPCB out from Heat Plate within 10 seconds.

- Heat plate temperature: 230°C max for Lead Solder and 230°C max for Lead-Free Solder.
- We recommend using the 58Bi-42Sn eutectic alloy for low-temp. and lead free soldering (melting point = 138 °C).
- When soldering, do not put stress on the LEDs during heating.
- After soldering, do not warp the circuit board.

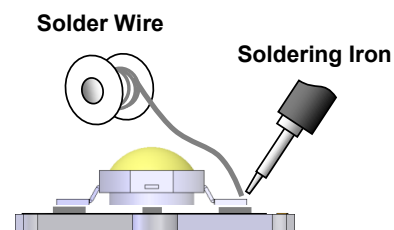
Manual Hand Soldering



Place Thermal Comductive Glue on the MCPCB.



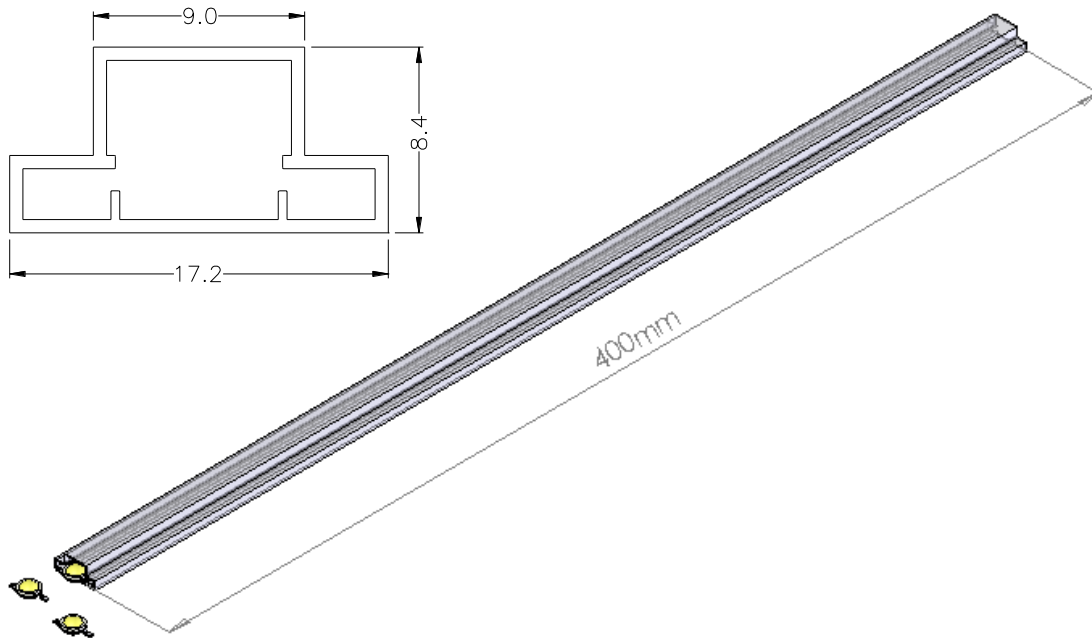
Place Emitter on the MCPCB.



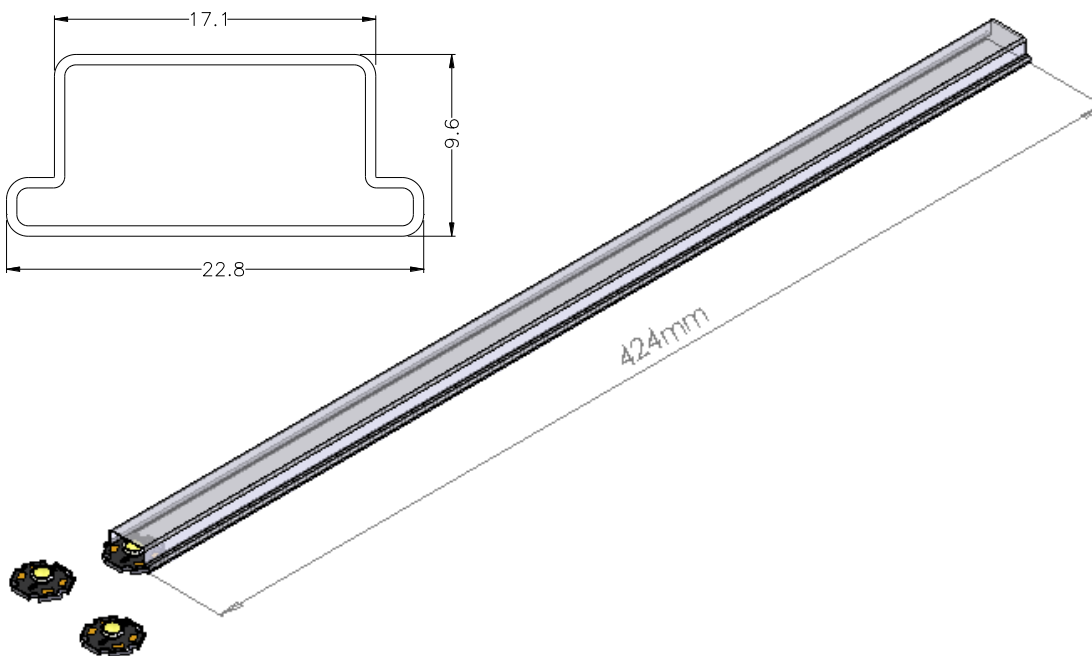
Use Soldering Iron to solder the leads of Emitter within 5 seconds.

- For prototype builds or small series production runs it possible to place and solder the emitters by hand.
- Solder tip temperature: 230°C max for Lead Solder and 260°C max for Lead-Free Solder.
- Avoiding damage to the emitter or to the MCPCB dielectric layer. Damage to the epoxy layer can cause a short circuit in the array.
- Do not let the solder contact from solder pad to back-side of MCPCB. This one will cause a short circuit and damage emitter.

Emitter Tube Packaging



Star Tube Packaging



Notes:

1. Emitter 50 pieces per tube and Star 20 pieces per tube.
2. Drawing not to scale.
3. All dimensions are in millimeters.
4. All dimensions without tolerances are for reference only.

****Please do not open the moisture barrier bag (MBB) more than one week. This may cause the leads of LED discoloration. We recommend storing ProLight's LEDs in a dry box after opening the MBB. The recommended storage conditions are temperature 5 to 30°C and humidity less than 40% RH.**

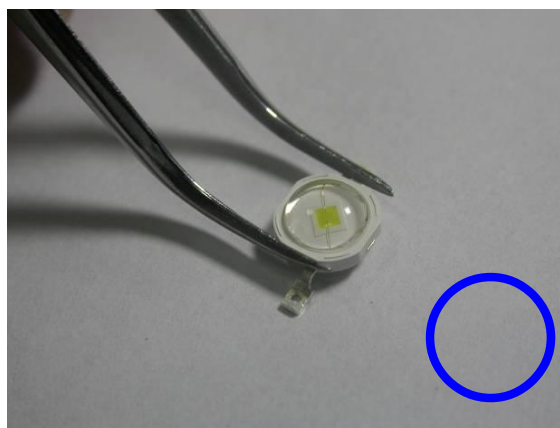
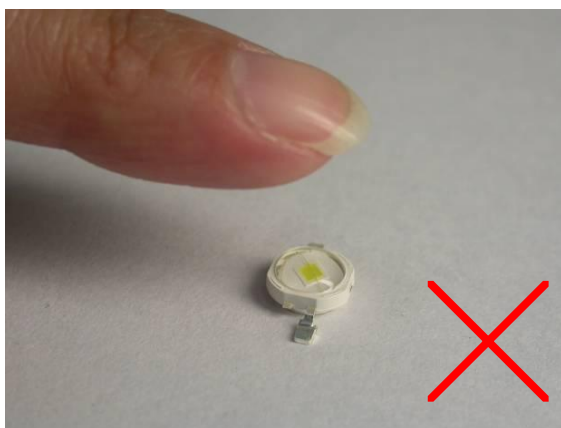
Precaution for Use

- **Storage**
Please do not open the moisture barrier bag (MBB) more than one week. This may cause the leads of LED discoloration. We recommend storing ProLight's LEDs in a dry box after opening the MBB. The recommended storage conditions are temperature 5 to 30°C and humidity less than 40% RH. It is also recommended to return the LEDs to the MBB and to reseal the MBB.
- The slug is not electrically neutral. Therefore, we recommend to isolate the heat sink.
- The slug is to be soldered. If not, please use the heat conductive adhesive.
- Any mechanical force or any excess vibration shall not be accepted to apply during cooling process to normal temperature after soldering.
- Please avoid rapid cooling after soldering.
- Components should not be mounted on warped direction of PCB.
- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, a heat plate should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.
- This device should not be used in any type of fluid such as water, oil, organic solvent and etc. When cleaning is required, isopropyl alcohol should be used.
- When the LEDs are illuminating, operating current should be decided after considering the package maximum temperature.
- The appearance, specifications and flux bin of the product may be modified for improvement without notice. Please refer to the below website for the latest datasheets.
<http://www.prolightopto.com/>

Handling of Silicone Lens LEDs

Notes for handling of silicone lens LEDs

- Please do not use a force of over 3kgf impact or pressure on the silicone lens, otherwise it will cause a catastrophic failure.
- The LEDs should only be picked up by making contact with the sides of the LED body.
- Avoid touching the silicone lens especially by sharp tools such as Tweezers.
- Avoid leaving fingerprints on the silicone lens.
- Please store the LEDs away from dusty areas or seal the product against dust.
- When populating boards in SMT production, there are basically no restrictions regarding the form of the pick and place nozzle, except that mechanical pressure on the silicone lens must be prevented.
- Please do not mold over the silicone lens with another resin. (epoxy, urethane, etc)



ProLight